



RoHS

COMPLIANT

N-Channel 100-V (D-S) MOSFET

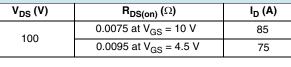
PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)			
100	0.0075 at V _{GS} = 10 V	85			
	0.0095 at V _{GS} = 4.5 V	75			

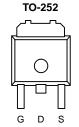
FEATURES

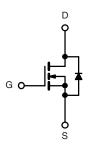
- TrenchFET[®] Power MOSFET ٠
- 100 % R_g Tested •
- 100 % UIS Tested

APPLICATIONS

- Primary Side Switch ٠
- Isolated DC/DC Converter







N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A = 25 \text{ °C}$, unless otherwise noted							
Parameter			Limit	Unit			
Drain-Source Voltage			100	V			
Gate-Source Voltage			± 20	v			
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C	la la	85				
	T _C = 125 °C	I _D	75 ^a				
Pulsed Drain Current	I _{DM}	300	A				
Avalanche Current	L = 0.1 mH	I _{AS}	75				
Single Pulse Avalanche Energy ^b		E _{AS}	280	mJ			
	$T_{C} = 25 \ ^{\circ}C \ (TO-252 \ and \ TO-251)$	PD	210	w			
Maximum Power Dissipation ^b	T _A = 25 °C (TO-252)	- 'D	3.25				
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C			

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^b	Steady State	R _{thJA}	40	50	°C/W	
Maximum Junction-to-Case	Sleady Slale	R _{thJC}	0.85	1.1	0/11	

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static		•		L		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	_D = 250 μA 100			v
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$			3	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
		V _{DS} = 100 V, V _{GS} = 0 V			1	μA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			50	
		V _{DS} = 100 V, V _{GS} = 0 V, T _J = 175 °C			250	1
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	120			Α
		V _{GS} = 10 V, I _D = 30 A		0.0075	0.010	_
	Б	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		0.0095	0.012	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 30 \text{ A}, \text{ T}_{J} = 125 ^{\circ}\text{C}$		0.017		Ω
		V_{GS} = 10 V, I _D = 30 A, T _J = 175 °C				
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	25			S
Dynamic ^b		•	•	•		
Input Capacitance	C _{iss}			4550		pF
Output Capacitance	C _{oss}	$V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz$		565		
Reverse Transfer Capacitance	C _{rss}			205		
Total Gate Charge ^c	Qg			105	160	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 85 \text{ A}$		17		nC
Gate-Drain Charge ^c	Q _{gd}			23		
Turn-On Delay Time ^c	t _{d(on)}			12	25	
Rise Time ^c	t _r	$V_{DD} = 50 \text{ V}, \text{ R}_{L} = 0.6 \Omega$		90	135	- ns
Turn-Off DelayTime ^c	t _{d(off)}	$I_D \cong 85 \text{ A}, V_{GEN} = 10 \text{ V}, \text{ R}_g = 2.5 \Omega$		55	85	
Fall Time ^c	t _f	-		130	195	
Source-Drain Diode Ratings and Char	acteristics T _C	= 25 °C ^b				
Continuous Current	ا _S				85	^
Pulsed Current	I _{SM}				240	A
Forward Voltage ^a	V _{SD}	I _F = 85 A, V _{GS} = 0 V		1.0	1.5	V
Reverse Recovery Time	t _{rr}			85	140	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 50 A, dl/dt = 100 A/μs		4.5	7	Α
Reverse Recovery Charge	Q _{rr}	1		0.17	0.35	μC

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

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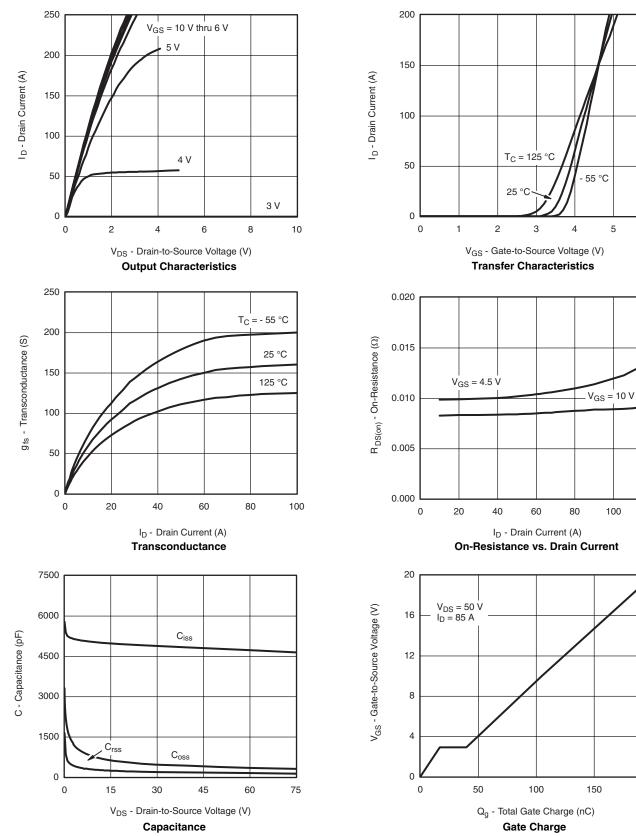
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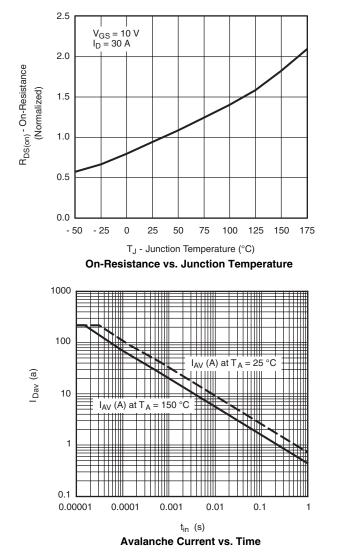
TYPICAL CHARACTERISTICS $T_A = 25 \text{ °C}$, unless otherwise noted

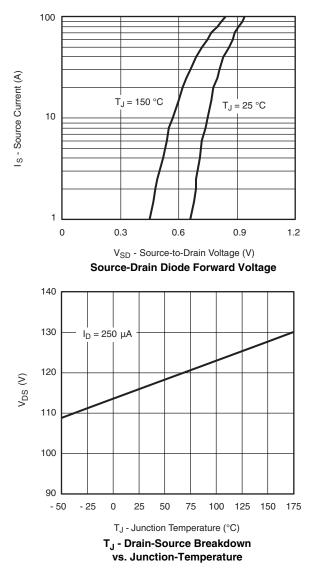


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TYPICAL CHARACTERISTICS $T_A = 25$ °C, unless otherwise noted

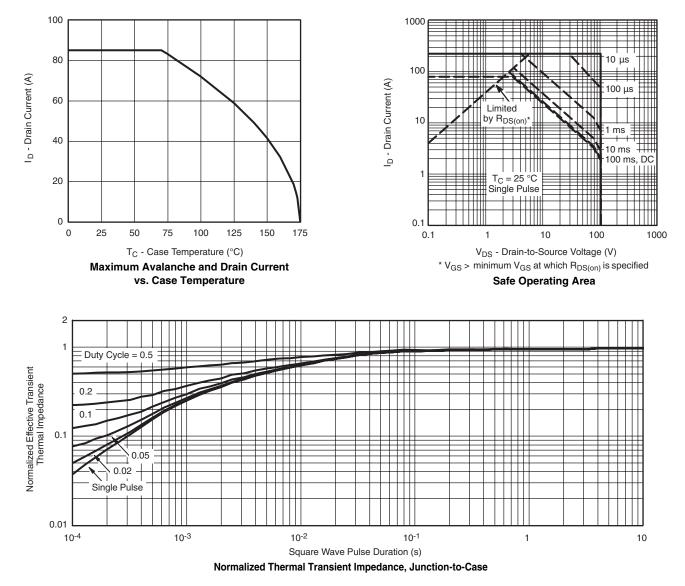




STD80N10F7

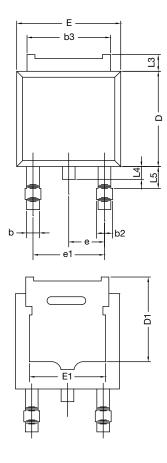
WBsemi www.VBsemi.tw

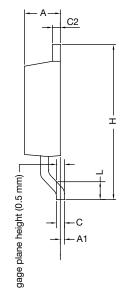
THERMAL RATINGS





TO-252AA CASE OUTLINE





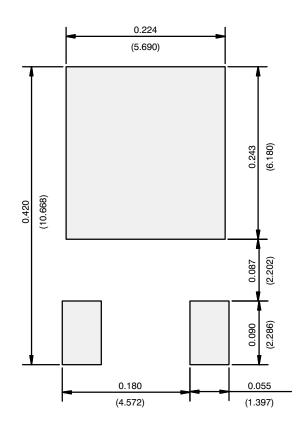
	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	5.21	-	0.205	-	
E	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28	BSC	0.090 BSC		
e1	4.56 BSC		0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.14	1.52	0.045	0.060	
ECN: X12-0247-Rev. M, 24-Dec-12 DWG: 5347					

Note

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)



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